

LTCC 带通滤波器 (Bandpass Filter)

HT-BFCN-3700+

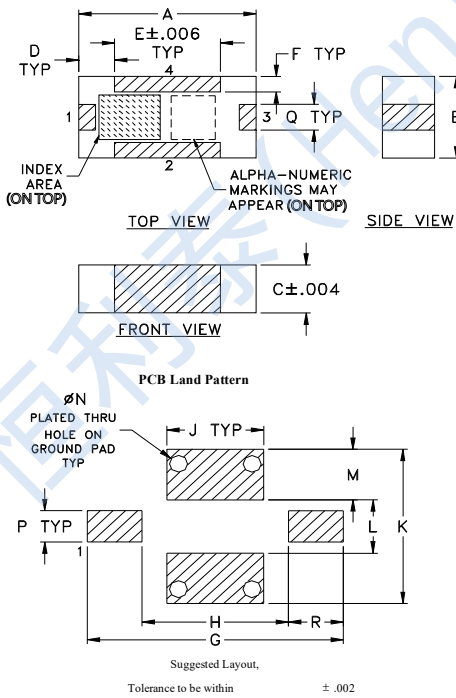
Features

- Small size
- Temperature stable
- Hermetically sealed
- LTCC construction

Applications

- Harmonic Rejection
- Transmitters / Receivers
- Test and Measurement

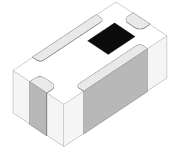
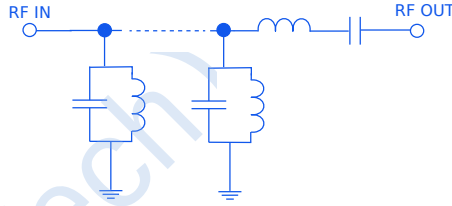
Outline Drawing



Outline Dimensions

A	B	C	D	E	F	G	H	J
.126	.063	.037	.026	.075	.012	.182	.104	.069
3.20	1.60	0.94	0.66	1.91	0.30	4.62	2.64	1.75
K	L	M	N	P	Q	R	wt	
.119	.041	.039	.013	.024	.020	.039	grams	
3.02	1.04	0.99	0.33	0.61	0.51	0.99	.020	

Functional Schematic



50 Ω
3000MHz to 4600MHz

Electrical Specifications(1,2) at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	3000 - 4600	—	3700	MHz
	Insertion Loss	3000 - 4600	—	1.9	dB
	VSWR	3000 - 4600	2.26	—	:1
Stop Band, Lower	Insertion Loss	2100	21	28	dB
	VSWR	2100	23	—	:1
Stop Band, Upper	Insertion Loss	5600 - 8000	10	24	dB
	VSWR	5600 - 8000	16	—	:1

Pad Connections

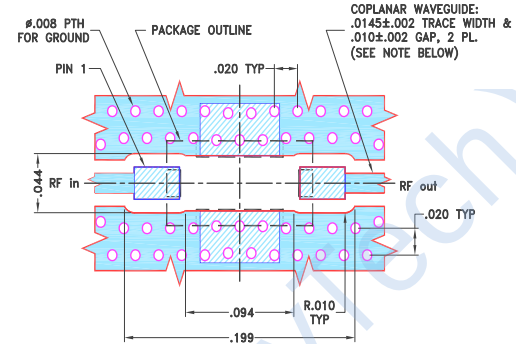
Input	1
Output	3
Ground	2, 4

Maximum Ratings

Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input*	2W max at 25°C

*Permanent damage may occur if any of these limits are exceeded.

Suggested PCB Layout

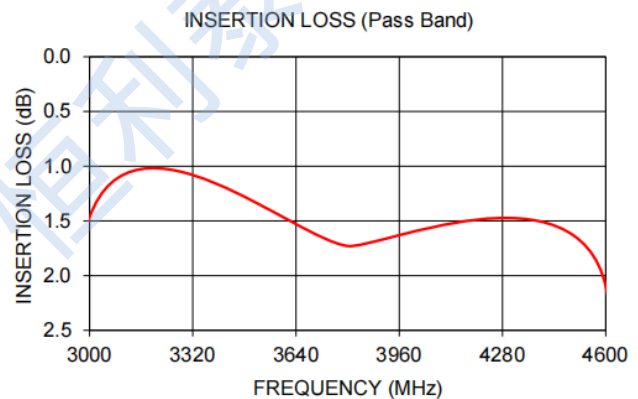
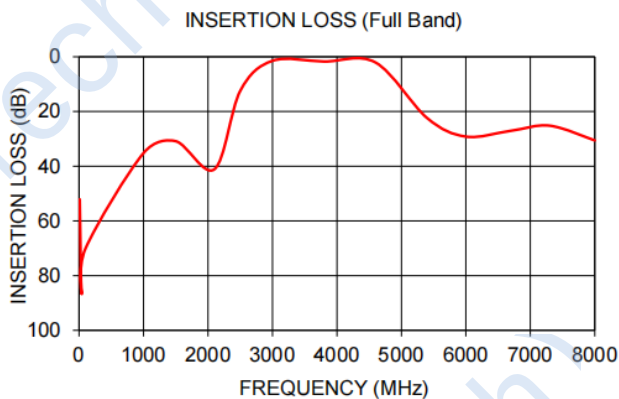


NOTES:

1. TRACE WIDTH PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .006"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Typical Performance Data at 25°C



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Typical Performance Data at 25°C

